OLED DISPLAY SPECIFICATION





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REX006448B

General Specification

The Features is described as follow:

■ Module Dimension: 18.46 × 18.10 × 1.26 mm

■ Active Area: 13.42 × 10.06 mm

■ Dot Matrix: 64 x 48 Dots

■ Pixel Size: 0.185 × 0.185 mm

■ Pixel Pitch: 0.210 × 0.210 mm

Display Mode: Passive Matrix

■ Drive Duty: 1/48 Duty

Display Color: Monochrome

■ IC: SSD1315

■ Interface:6800, 8080, 4 -wire SPI, I2C

■ Size:0.66-inch

Interface Pin Function

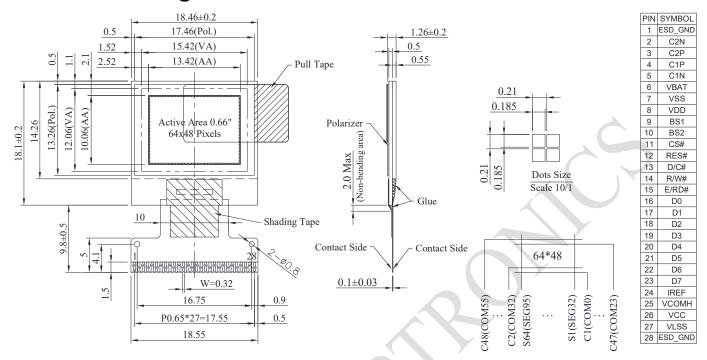
Pin No.	Symbol	Function					
1	ESD- GND	It should be connected to ground.					
2	C2N	C1P/C1N -	Pin for charge p	ump capacitor; Co	onnect to each other with a		
3	C2P	capacitor.					
4	C1P	C2P/C2N – Pin for charge pump capacitor; Connect to each other with a					
5	C1N	capacitor.					
		Power supply for charge pump regulator circuit.					
		Status	VBAT	VDD	VCC		
6	VBAT	pump	Connect to external VBAT source	Connect to external VDD source	A capacitor should be connected between this pin and VSS		
		Disable charge pump	Keep float	Connect to external VDD source	Connect to external VCC source		
7	VSS	This is a gro	ound pin.	/			
8	VDD	Power supp	ly pin for core lo	gic operation.			
9	BS1	These pins	These pins are MCU interface selection input.				
	BS2	See the following table:					
			BS1	BS2			
10		I2C	1 0	0			
10		4-wire SPI 8-bit 6800 Pa	rallel $\begin{bmatrix} 0 \\ 0 \end{bmatrix}$	0 1			
		8-bit 8080 Pa	rallel 1	1			
11	CS#	The chip is enabled for MCU communication only when CS# is pulled LOW					
''		(active LOW).					
12	RES#	This pin is reset signal input. When the pin is low, initialization of the chip is					
14		executed. Keep this pin HIGH (i.e. connect to VDD) during normal operation.					
12	D/C#	This pin is Data/Command control pin connecting to the MCU.					
13		When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data.					

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		When the pin is pulled LOW, the data at D[7:0] will be transferred
		This is read / write control input pin connecting to the MCU interface.
		When interfacing to a 6800-series microprocessor, this pin will be used as
		Read/Write (R/W#) selection input. Read mode will be carried out when this
14	R/W#	pin is pulled HIGH (i.e. connect to VDD) and write mode when LOW.
'		When 8080 interface mode is selected, this pin will be the Write (WR#) input.
		Data write operation is initiated when this pin is pulled LOW and the chip is
		selected.
		When serial or I2C interface is selected, this pin must be connected to VSS.
		This pin is MCU interface input.
		When 6800 interface mode is selected, this pin will be used as the Enable
		(E) signal. Read/write operation is initiated when this pin is pulled HIGH and
15	E/RD#	the chip is selected.
	E/RD#	When 8080 interface mode is selected, this pin receives the Read (RD#)
		signal. Read operation is initiated when this pin is pulled LOW and the chip
		is selected.
		When serial or I2C interface is selected, this pin must be connected to VSS.
		These are 8-bit bi-directional data bus to be connected to the
		microprocessor's data bus. When serial interface mode is selected, D0 will
16~23	D0~D7	be the serial clock input: SCLK; D1 will be the serial data input: SDIN.
		When I2C mode is selected, D2, D1 should be tied together and serve as
		SDAout, SDAin in application and D0 is the serial clock input, SCL.
	IREF	This is segment output current reference pin.
24		When external IREF is used, a resistor should be connected between this
24		pin and VSS to maintain the IREF current at 30uA.
		When internal IREF is used, this pin should be kept NC.
25	VСОМН	COM signal deselected voltage level.
23		A capacitor should be connected between this pin and VSS.
	VCC	Power supply for panel driving voltage. This is also the most positive power
26		voltage supply pin.
20		When charge pump is enabled, a capacitor should be connected between
		this pin and VSS.
27	VLSS	This is an analog ground pin. It should be connected to VSS externally.
		•

28	ESD	It should be connected to ground
	GND	It should be connected to ground.



Contour Drawing



The non-specified tolerance of dimension is $\pm 0.3\ mm$.

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	VDD	0	4.0	V
Charge Pump Regulator Supply Voltage	VBAT	0	6.0	Cy
Supply Voltage for Display	VCC	0	18.0	V
Operating Temperature	TOP	-30	+70	°C
Storage Temperature	TSTG	-30	+70	°C

Electrical Characteristics

DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	1.65	3.0	3.3	V
Supply Voltage for Display (Supplied Externally)	VCC	_	6.0	7.5	8.0	V
Charge Pump Regulator Supply Voltage	VBAT	_	3.0	3.3	4.5	V
Charge Pump Output Voltage for Display (Generated by Internal DC/DC)	Charge Pump VCC	-	7.0	7.5	_	V
Input High Volt	VIH		0.8×VDD	_	VDD	V
Input Low Volt	VIL		0	_	0.2×VDD	V
Output High Volt	VOH		0.9×VDD	_	VDD	V
Output Low Volt	VOL	_	0	_	0.1×VDD	V
Display 50% Pixel on (VCC Supplied Externally)	ICC	VCC=7.5V	_	3	6	mA
Display 50% Pixel on (VCC Generated by Internal DC/DC)	IBAT	_	_	15	30	mA